

## Supporting information

### **Ionic Liquid Bridging Buried Interface for High-Performance Flexible Self-Powered Perovskite Nanowire Photodetectors with Excellent Mechanical Stability**

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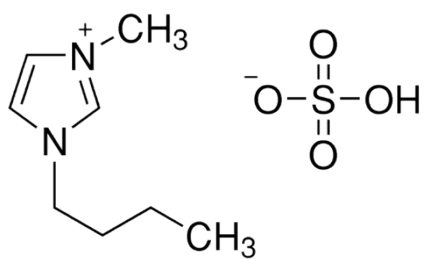


Figure S1. The molecular structure of ionic liquid BMIMHSO<sub>4</sub>.

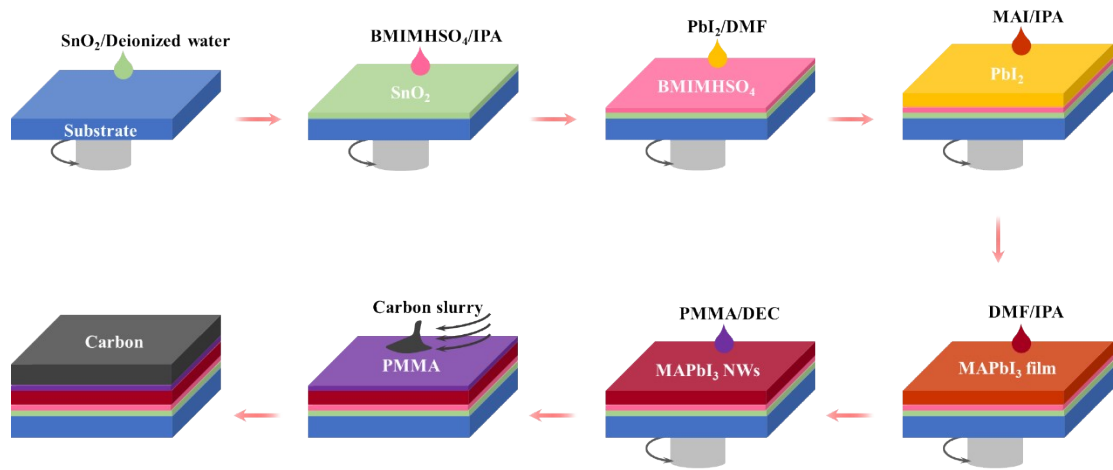


Figure S2. The preparation flow chart of the device with BMIMHSO<sub>4</sub> bridging the buried interface.

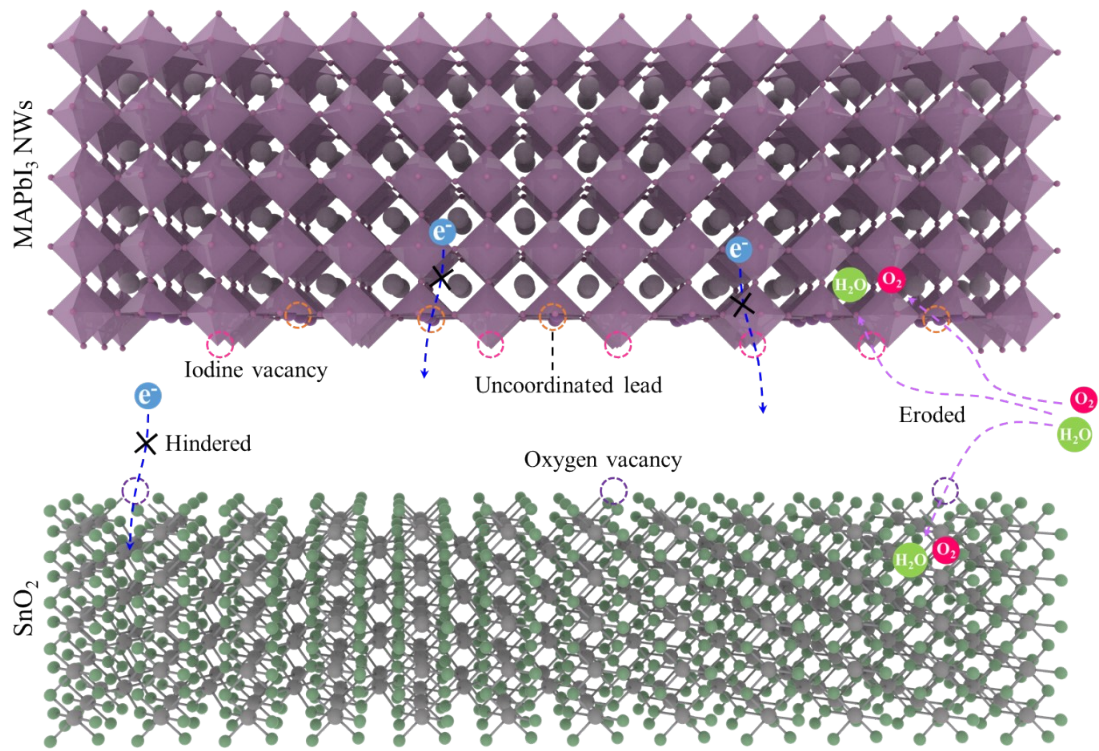


Figure 3. Schematic illustration of the buried interface defects between SnO<sub>2</sub> and MAPbI<sub>3</sub> NWs affecting the device performance and stability.

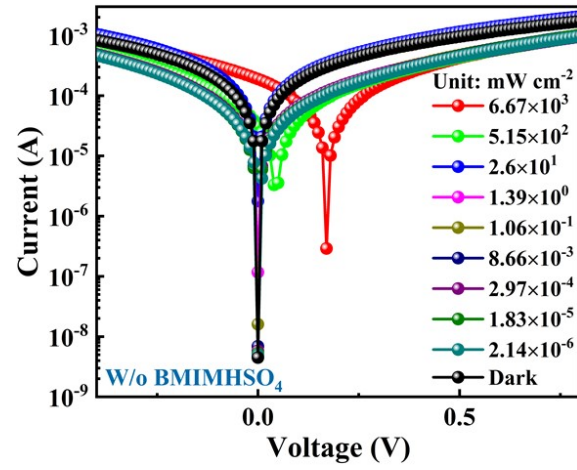


Figure S4. I-V curves of the rigid device without BMIMHSO<sub>4</sub> bridging buried interface under different light intensities.

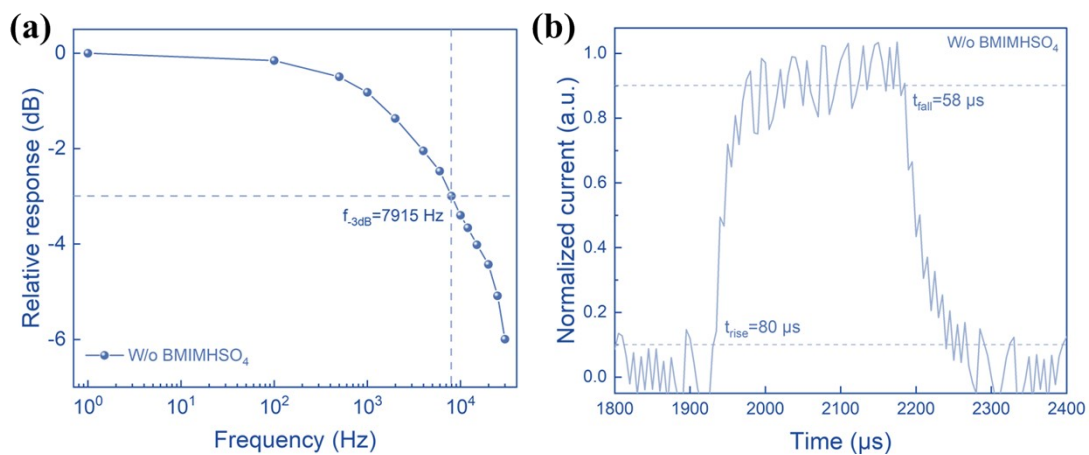


Figure S5. (a) -3 dB cut off frequency and (b) Response time of the rigid device without BMIMHS<sub>4</sub> bridging buried interface.

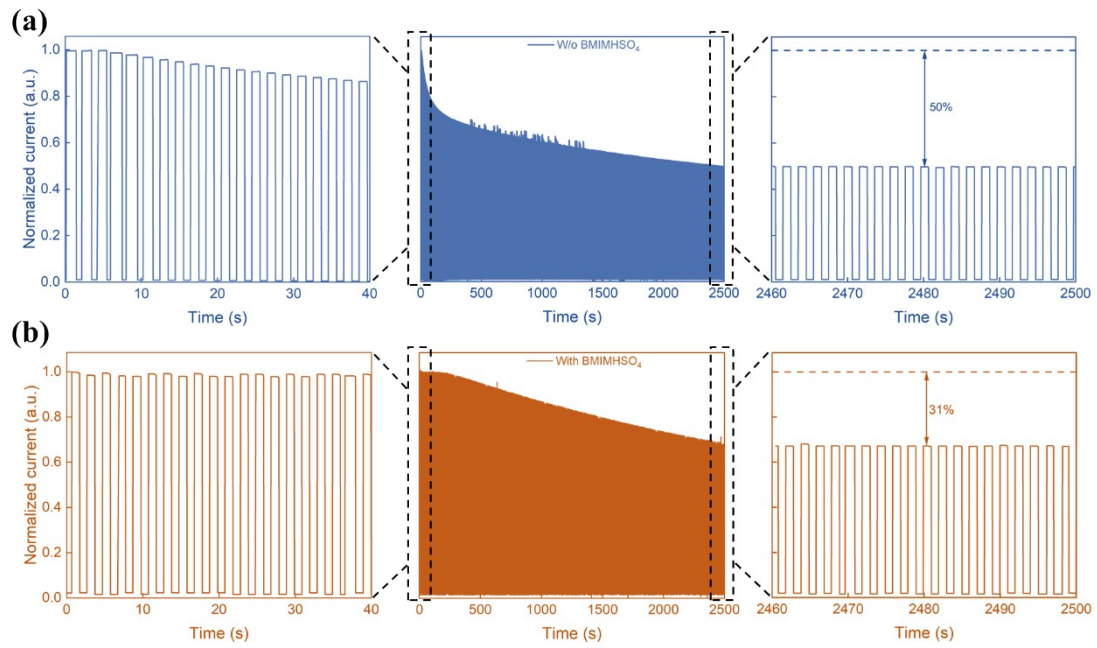


Figure S6. Normalized I-t curve of the rigid device (a) without and (b) with BMIMHS<sub>4</sub> bridging buried interface under continuous illumination for 2500 s.

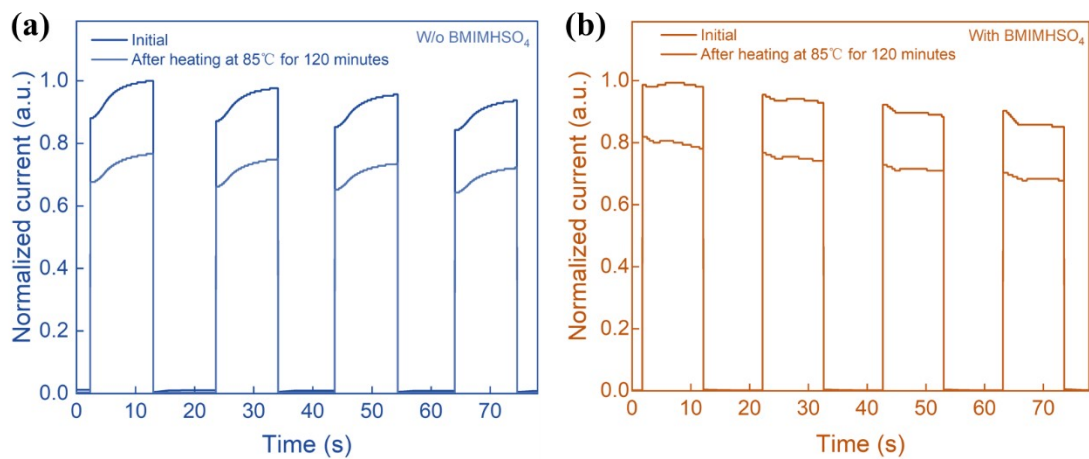


Figure S7. Normalized I-t curve of the rigid device (a) without and (b) with BMIMHSO<sub>4</sub> bridging buried interface before and after heating at 85°C for 120 minutes.

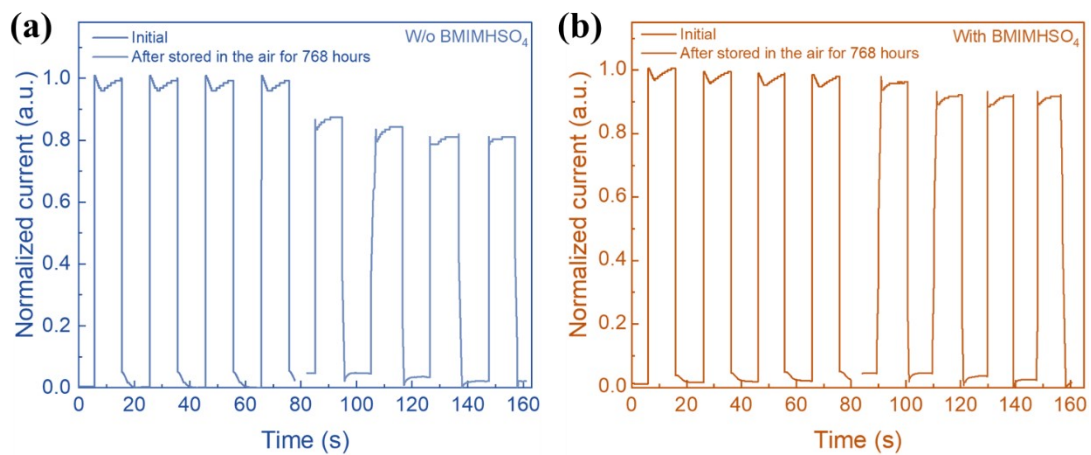


Figure S8. Normalized I-t curve of the rigid device (a) without and (b) with BMIMHSO<sub>4</sub> bridging buried interface before and after stored in the air (45%-80% humidity) for 768 hours.